### **INTEGRATED CIRCUITS**

# DATA SHEET

# 74AHC1G66; 74AHCT1G66 Bilateral switch

Product specification Supersedes data of 2002 Feb 15 2002 Jun 06





### **Bilateral** switch

### 74AHC1G66; 74AHCT1G66

#### **FEATURES**

- Very low ON-resistance:
  - 26  $\Omega$  (typical) at  $V_{CC} = 3.0 \text{ V}$
  - 16  $\Omega$  (typical) at  $V_{CC} = 4.5 \text{ V}$
  - 14  $\Omega$  (typical) at  $V_{CC} = 5.5 \text{ V}$ .
- ESD protection:
  - HBM EIA/JESD22-A114-A exceeds 2000 V
  - MM EIA/JESD22-A115-A exceeds 200 V
  - CDM EIA/JESD22-C101 exceeds 1000 V.
- · High noise immunity
- · Low power dissipation
- · Balanced propagation delays
- SOT353 and SOT753 package
- · Output capability: non standard
- Specified from -40 to +125 °C.

#### **DESCRIPTION**

The 74AHC1G/AHCT1G66 is a high-speed Si-gate CMOS device.

The 74AHC1G/AHCT1G66 provides an analog switch. The switch has two input/output pins (Y and Z) and an active HIGH enable input pin (E). When pin E is LOW, the analog switch is turned off.

#### **QUICK REFERENCE DATA**

Ground = 0 V;  $T_{amb} = 25 \,^{\circ}\text{C}$ ;  $t_r = t_f \le 3 \,\text{ns}$ .

| SYMBOL                             | PARAMETER                          | CONDITIONS  | TYF   | TYPICAL |      |  |  |
|------------------------------------|------------------------------------|---|-------|---------|------|--|--|
| STWIBUL                            | PARAMETER                          | CONDITIONS  | AHC1G | AHCT1G  | UNIT |  |  |
| t <sub>PZH</sub> /t <sub>PZL</sub> | turn-on time E to V <sub>os</sub>  | $C_L = 15 \text{ pF}; R_L = 1 \text{ k}\Omega;$<br>$V_{CC} = 5 \text{ V}$ | 3     | 3       | ns   |  |  |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | turn-off time E to V <sub>os</sub> | $C_L = 15 \text{ pF}; R_L = 1 \text{ k}\Omega;$<br>$V_{CC} = 5 \text{ V}$ | 5     | 5       | ns   |  |  |
| C <sub>I</sub>                     | input capacitance                  |   | 2     | 2       | pF   |  |  |
| C <sub>PD</sub>                    | power dissipation capacitance      | C <sub>L</sub> = 50 pF; f = 10 MHz;<br>notes 1 and 2                      | 13    | 15      | pF   |  |  |
| C <sub>S</sub>                     | switch capacitance                 |   | 4     | 4       | pF   |  |  |

### Notes

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + ((C_L + C_S) \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

C<sub>S</sub> = maximum switch capacitance in pF;

 $V_{CC}$  = supply voltage in Volts.

2. The condition is  $V_I = GND$  to  $V_{CC}$ .

### Bilateral switch

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### **FUNCTION TABLE**

See note 1.

| INPUT E | SWITCH |
|---------|--------|
| L       | OFF    |
| Н       | ON     |

#### Note

1. H = HIGH voltage level;

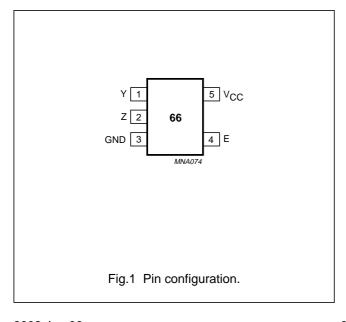
L = LOW voltage level.

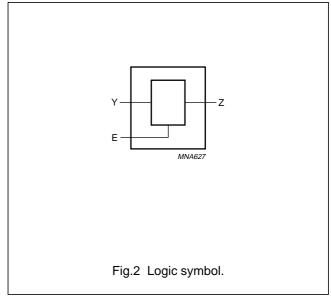
### **ORDERING INFORMATION**

|              | PACKAGE              |      |         |          |        |         |  |  |  |  |  |
|--------------|----------------------|------|---------|----------|--------|---------|--|--|--|--|--|
| TYPE NUMBER  | TEMPERATURE<br>RANGE | PINS | PACKAGE | MATERIAL | CODE   | MARKING |  |  |  |  |  |
| 74AHC1G66GW  | -40 to +125 °C       | 5    | SC-88A  | plastic  | SOT353 | AL      |  |  |  |  |  |
| 74AHCT1G66GW | -40 to +125 °C       | 5    | SC-88A  | plastic  | SOT353 | CL      |  |  |  |  |  |
| 74AHC1G66GV  | -40 to +125 °C       | 5    | SC-74A  | plastic  | SOT753 | A66     |  |  |  |  |  |
| 74AHCT1G66GV | -40 to +125 °C       | 5    | SC-74A  | plastic  | SOT753 | C66     |  |  |  |  |  |

### **PINNING**

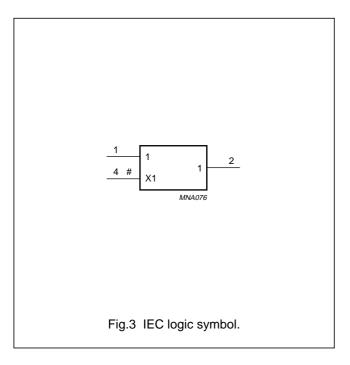
| PIN | SYMBOL          | DESCRIPTION                |
|-----|-----------------|----------------------------|
| 1   | Υ               | independent input/output   |
| 2   | Z               | independent output/input   |
| 3   | GND             | ground (0 V)               |
| 4   | E               | enable input (active HIGH) |
| 5   | V <sub>CC</sub> | supply voltage             |

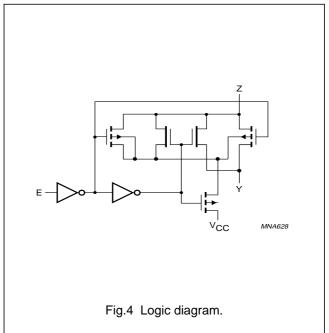




### Bilateral switch

# 74AHC1G66; 74AHCT1G66





### Bilateral switch

74AHC1G66; 74AHCT1G66

#### RECOMMENDED OPERATING CONDITIONS

| SYMBOL                          | PARAMETER                     | CONDITIONS                               | 74   | IAHC1G | 66              | 74   | AHCT10 | <b>9</b> 66     | UNIT |
|---------------------------------|-------------------------------|--|------|--------|-----------------|------|--------|-----------------|------|
| STIVIBUL                        | PARAMETER                     | CONDITIONS                               | MIN. | TYP.   | MAX.            | MIN. | TYP.   | MAX.            | UNII |
| V <sub>CC</sub>                 | supply voltage                |  | 2.0  | 5.0    | 5.5             | 4.5  | 5.0    | 5.5             | V    |
| VI                              | input voltage                 |  | 0    | _      | 5.5             | 0    | _      | 5.5             | V    |
| Vs                              | switch voltage                |  | 0    | _      | V <sub>CC</sub> | 0    | _      | V <sub>CC</sub> | V    |
| T <sub>amb</sub>                | operating ambient temperature | see DC and AC characteristics per device | -40  | +25    | +125            | -40  | +25    | +125            | °C   |
| t <sub>r</sub> , t <sub>f</sub> | input rise and fall times     | $V_{CC} = 3.3 \pm 0.3 \text{ V}$         | _    | _      | 100             | _    | _      | _               | ns/V |
|                                 |                               | $V_{CC} = 5.0 \pm 0.5 \text{ V}$         | _    | _      | 20              | _    | _      | 20              | ns/V |

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V); note 1.

| SYMBOL                             | PARAMETER                      | CONDITIONS  | MIN. | MAX. | UNIT |
|------------------------------------|--------------------------------|---|------|------|------|
| V <sub>CC</sub>                    | supply voltage                 |   | -0.5 | +7.0 | V    |
| I <sub>IK</sub>                    | input diode current            | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$                   | _    | -20  | mA   |
| I <sub>SK</sub>                    | switch diode current           | $V_{\rm S}$ < -0.5 V or $V_{\rm S}$ > $V_{\rm CC}$ + 0.5 V                    | _    | ±20  | mA   |
| Is                                 | switch source or sink current  | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ | _    | ±25  | mA   |
| I <sub>CC</sub> , I <sub>GND</sub> | V <sub>CC</sub> or GND current |   | _    | ±75  | mA   |
| T <sub>stg</sub>                   | storage temperature            |   | -65  | +150 | °C   |
| P <sub>D</sub>                     | power dissipation per package  | for temperature range from -40 to +125 °C                                     | _    | 250  | mW   |

### Note

1. To avoid drawing  $V_{CC}$  current out of pin Z, when switch current flows into pin Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into pin Z, no  $V_{CC}$  current will flow out of pin Y. In this case there is no limit for the voltage drop across the switch, but the voltage at pins Y and Z may not exceed  $V_{CC}$  or GND.

### Bilateral switch

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### **DC CHARACTERISTICS**

### Type 74AHC1G66

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

|                 |                                       | TEST CONDITION   | ONS             |      |      | 1    | amb (°C | <b>C)</b> |        |      |      |
|-----------------|---------------------------------------|--|-----------------|------|------|------|---------|-----------|--------|------|------|
| SYMBOL          | PARAMETER                             | OTHER  | V <sub>cc</sub> |      | 25   |      | −40 t   | o +85     | -40 to | +125 | UNIT |
|                 |                                       | OTHER  | (V)             | MIN. | TYP. | MAX. | MIN.    | MAX.      | MIN.   | MAX. |      |
| V <sub>IH</sub> | HIGH-level input                      |  | 2.0             | 1.5  | _    | _    | 1.5     | _         | 1.5    | _    | V    |
|                 | voltage                               |  | 3.0             | 2.1  | _    | _    | 2.1     | _         | 2.1    | _    | V    |
|                 |                                       |  | 5.5             | 3.85 | _    | -    | 3.85    | _         | 3.85   | _    | V    |
| $V_{IL}$        | LOW-level input                       |  | 2.0             | _    | _    | 0.5  | _       | 0.5       | _      | 0.5  | V    |
|                 | voltage                               |  | 3.0             | _    | _    | 0.9  | _       | 0.9       | _      | 0.9  | V    |
|                 |                                       |  | 5.5             | -    | _    | 1.65 | _       | 1.65      | _      | 1.65 | V    |
| ILI             | input leakage current                 | $V_I = V_{CC}$ or GND  | 5.5             | _    | _    | 0.1  | _       | 1.0       | _      | 2.0  | μΑ   |
| Is              | analog switch<br>current, OFF-state   | $V_I = V_{IH} \text{ or } V_{IL};$<br>$ V_S  = V_{CC} - GND;$<br>see Fig.5         | 5.5             | _    | _    | 0.1  | _       | 1.0       | _      | 4.0  | μΑ   |
|                 | analog switch<br>current, ON-state    | $V_I = V_{IH}$ or $V_{IL}$ ;<br>$ V_S  = V_{CC} - GND$ ;<br>see Fig.6              | 5.5             | _    | _    | 0.1  | _       | 1.0       | _      | 4.0  | μΑ   |
| I <sub>CC</sub> | quiescent supply current              | $V_I = V_{CC}$ or GND;<br>$V_{is} = GND$ or $V_{CC}$ ;<br>$V_{os} = V_{CC}$ or GND | 5.5             | _    | _    | 1.0  | _       | 10        | _      | 40   | μΑ   |
| Cı              | input capacitance of enable input (E) |  |                 | _    | 2    | 10   | _       | 10        | _      | 10   | pF   |
| Cs              | maximum switch capacitance            | independent I/O  |                 | _    | 4    | 10   | _       | 10        | _      | 10   | pF   |

### Bilateral switch

# 74AHC1G66; 74AHCT1G66

Type 74AHCT1G66

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

|                  |  | TEST CONDIT  | TIONS               |      |      | 7    | ր <sub>amb</sub> (°C | C)    |        |      |      |
|------------------|--|--|---------------------|------|------|------|----------------------|-------|--------|------|------|
| SYMBOL           | PARAMETER                                      | OTHER  | V 00                |      | 25   |      | −40 t                | o +85 | -40 to | +125 | UNIT |
|                  |  | OTHER  | V <sub>CC</sub> (V) | MIN. | TYP. | MAX. | MIN.                 | MAX.  | MIN.   | MAX. |      |
| V <sub>IH</sub>  | HIGH-level input voltage                       |  | 4.5 to 5.5          | 2.0  | _    | _    | 2.0                  | _     | 2.0    | -    | V    |
| V <sub>IL</sub>  | LOW-level input voltage                        |  | 4.5 to 5.5          | _    | -    | 0.8  | _                    | 0.8   | _      | 0.8  | V    |
| ILI              | input leakage current                          | $V_I = V_{CC}$ or GND  | 5.5                 | _    | _    | 0.1  | _                    | 1.0   | _      | 2.0  | μΑ   |
| Is               | analog switch<br>current,<br>OFF-state         | $V_I = V_{IH}$ or $V_{IL}$ ;<br>$ V_S  = V_{CC} - GND$ ;<br>see Fig.5              | 5.5                 | _    | _    | 0.1  | _                    | 1.0   | _      | 4.0  | μА   |
|                  | analog switch<br>current,<br>ON-state          | $V_I = V_{IH}$ or $V_{IL}$ ;<br>$ V_S  = V_{CC} - GND$ ;<br>see Fig.6              | 5.5                 | _    | _    | 0.1  | _                    | 1.0   | _      | 4.0  | μΑ   |
| Icc              | quiescent<br>supply current                    | $V_I = V_{CC}$ or GND;<br>$V_{is} = GND$ or $V_{CC}$ ;<br>$V_{os} = V_{CC}$ or GND | 5.5                 | _    | _    | 1.0  | _                    | 10    | _      | 40   | μΑ   |
| Δl <sub>CC</sub> | additional<br>quiescent<br>supply current      | $V_I = 3.4 \text{ V};$<br>other inputs at $V_{CC}$ or GND; $I_O = 0$               | 5.5                 | _    | _    | 1.35 | _                    | 1.5   | _      | 1.5  | mA   |
| Cı               | input<br>capacitance of<br>enable<br>input (E) |  |                     | _    | 2    | 10   | _                    | 10    | _      | 10   | pF   |
| Cs               | maximum<br>switch<br>capacitance               | independent I/O  |                     | _    | 4    | 10   | _                    | 10    | _      | 10   | pF   |

### Bilateral switch

74AHC1G66; 74AHCT1G66

### Type 74AHC1G66 and 74AHCT1G66

For 74AHC1G66:  $V_{CC}$  = 2.0, 3.0, 4.5 and 5.5 V; or 74AHCT1G66:  $V_{CC}$  = 4.5 and 5.5 V.

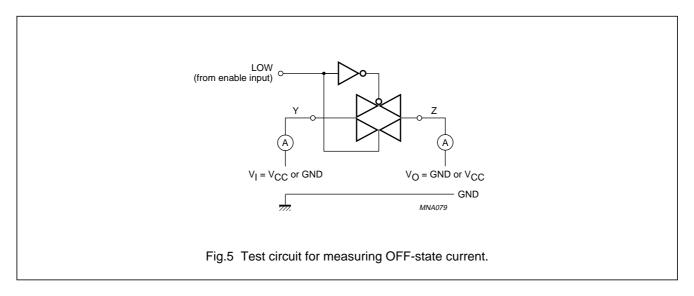
|                         |  |   |          |                    |      | T <sub>amb</sub> (°C | )     |        |        |      |
|-------------------------|--|---|----------|--------------------|------|----------------------|-------|--------|--------|------|
| SYMBOL                  | PARAMETER                                  | TEST CONDITIONS   |          | 25                 |      | −40 t                | o +85 | -40 to | 0 +125 | UNIT |
|                         |  |   | MIN.     | TYP.               | MAX. | MIN.                 | MAX.  | MIN.   | MAX.   |      |
| V <sub>CC</sub> = 2.0   | V; I <sub>S</sub> = 1 mA; V <sub>I</sub> = | V <sub>IH</sub> or V <sub>IL</sub> ; see Figs             | 7 and 8  |                    |      |                      |       |        |        |      |
| R <sub>ON</sub>         | ON-resistance (peak)                       | $V_{is} = V_{CC}$ to GND                                  | _        | 148 <sup>(1)</sup> | _    | _                    | _     | _      | _      | Ω    |
|                         | ON-resistance                              | V <sub>is</sub> = GND                                     | _        | 30                 | _    | _                    | _     | _      | _      | Ω    |
|                         | (rail)                                     | $V_{is} = V_{CC}$   | _        | 28                 | _    | _                    | _     | _      | _      | Ω    |
| V <sub>CC</sub> = 3.0 t | o 3.6 V; I <sub>S</sub> = 10 i             | mA; $V_I = V_{IH}$ or $V_{IL}$ ;                          | see Figs | 7 and 8            |      |                      |       |        |        |      |
| R <sub>ON</sub>         | ON-resistance (peak)                       | $V_{is} = V_{CC}$ to GND                                  | _        | 28                 | 50   | _                    | 70    | _      | 110    | Ω    |
|                         | ON-resistance                              | V <sub>is</sub> = GND                                     | _        | 20                 | 50   | _                    | 65    | _      | 90     | Ω    |
|                         | (rail)                                     | $V_{is} = V_{CC}$   | _        | 18                 | 50   | _                    | 65    | _      | 90     | Ω    |
| V <sub>CC</sub> = 4.5 t | to 5.5 V; I <sub>S</sub> = 10 I            | mA; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; | see Figs | 7 and 8            |      |                      |       |        | •      | •    |
| R <sub>ON</sub>         | ON-resistance (peak)                       | $V_{is} = V_{CC}$ to GND                                  | -        | 15                 | 30   | _                    | 40    | _      | 60     | Ω    |
|                         | ON-resistance                              | V <sub>is</sub> = GND                                     | _        | 15                 | 22   | _                    | 26    | _      | 40     | Ω    |
|                         | (rail)                                     | $V_{is} = V_{CC}$   | -        | 13                 | 22   | _                    | 26    | -      | 40     | Ω    |

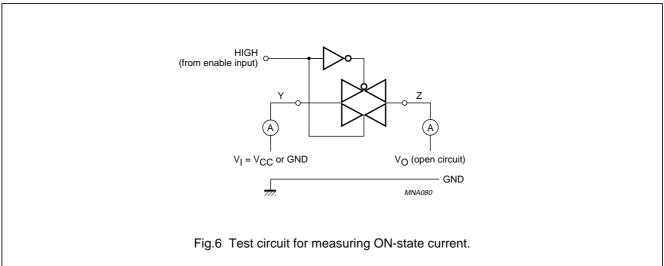
#### Note

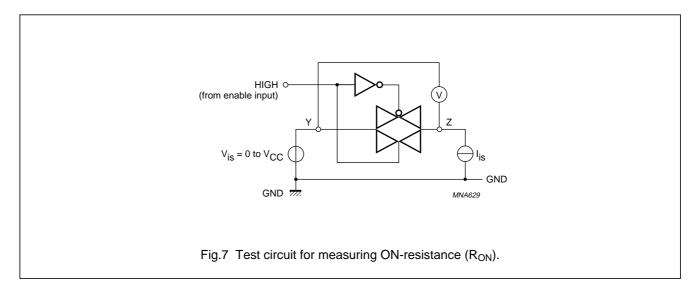
<sup>1.</sup> At supply voltage approaching 2 V, the analog switch ON-resistance becomes extremely non-linear. Therefore, it is recommended that these devices are used to transmit digital signals only, when using this supply voltage.

### Bilateral switch

# 74AHC1G66; 74AHCT1G66

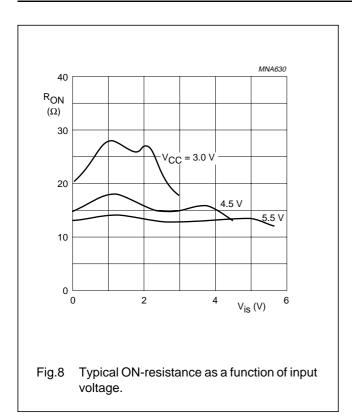






### Bilateral switch

# 74AHC1G66; 74AHCT1G66



### Bilateral switch

# 74AHC1G66; 74AHCT1G66

### **AC CHARACTERISTICS**

Type 74AHC1G66

 $GND = 0 \ V; \ t_r = t_f \leq 3 \ ns.$ 

|                                    |  | TEST CONDITIO      | NS   |      |      | 1    | ր <sub>amb</sub> (°C | <b>C)</b> |        |      |      |
|------------------------------------|--|--------------------|------|------|------|------|----------------------|-----------|--------|------|------|
| SYMBOL                             | PARAMETER  | WAVEFORMS          | CL   |      | 25   |      | −40 t                | o +85     | -40 to | +125 | UNIT |
|                                    |  | WAVEFORMS          | (pF) | MIN. | TYP. | MAX. | MIN.                 | MAX.      | MIN.   | MAX. |      |
| V <sub>CC</sub> = 2.0              | $V$ ; $R_L = 1 kΩ$ ; note 1                          |                    | '    | !    | !    | •    | !                    |           | !      | '    | !    |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay V <sub>is</sub> to V <sub>os</sub> | see Figs 13 and 16 | 50   | _    | 2.2  | 5.0  | _                    | 6.0       | _      | 7.0  | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | turn-on time   | see Figs 14 and 16 | 15   | _    | 7.0  | 25.0 | -                    | 33.0      | -      | 40.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50   | _    | 11.0 | 35.0 | _                    | 46.0      | _      | 57.0 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | turn-off time  | see Figs 14 and 16 | 15   | _    | 9.0  | 25.0 | _                    | 33.0      | _      | 40.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50   | _    | 13.0 | 35.0 | _                    | 46.0      | -      | 57.0 | ns   |
| $V_{CC} = 3.0$                     | to 3.6 V; $R_L = 1 \text{ k}\Omega$ ;                | note 1             |      |      |      |      |                      |           |        |      |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay V <sub>is</sub> to V <sub>os</sub> | see Figs 13 and 16 | 50   | _    | 1.0  | 2.0  | _                    | 3.0       | _      | 4.0  | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | turn-on time   | see Figs 14 and 16 | 15   | _    | 4.0  | 11.0 | _                    | 14.0      | _      | 18.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50   | _    | 5.8  | 15.0 | _                    | 20.0      | _      | 25.0 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | turn-off time  | see Figs 14 and 16 | 15   | _    | 6.0  | 11.0 | _                    | 14.0      | _      | 18.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50   | _    | 8.4  | 15.0 | _                    | 20.0      | _      | 25.0 | ns   |
| V <sub>CC</sub> = 4.5              | to 5.5 V; $R_L = 1 \text{ k}\Omega$ ;                | note 1             |      |      |      | _    |                      |           |        | •    |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay V <sub>is</sub> to V <sub>os</sub> | see Figs 13 and 16 | 50   | _    | 0.6  | 1.0  | _                    | 2.0       | _      | 3.0  | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | turn-on time   | see Figs 14 and 16 | 15   | _    | 3.0  | 8.0  | _                    | 10.0      | _      | 13.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50   | _    | 4.4  | 11.0 | _                    | 13.0      | _      | 17.0 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | turn-off time  | see Figs 14 and 16 | 15   | _    | 5.0  | 8.0  | _                    | 10.0      | -      | 13.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50   | _    | 6.1  | 11.0 | _                    | 13.0      | -      | 17.0 | ns   |

### Note

<sup>1.</sup> Typical values are measured at  $V_{CC}$  = 2.0 V;  $V_{CC}$  = 3.3 V or  $V_{CC}$  = 5.0 V and  $T_{amb}$  = 25 °C.

### Bilateral switch

74AHC1G66; 74AHCT1G66

#### **74AHCT1G66**

GND = 0 V;  $t_r = t_f \le 3$  ns.

|                                    |  | TEST CONDITIO      | NS             | T <sub>amb</sub> (°C) |      |      |      |       |        |      |      |
|------------------------------------|--|--------------------|----------------|-----------------------|------|------|------|-------|--------|------|------|
| SYMBOL                             | PARAMETER  | WAVEFORMS          | CL             |                       | 25   |      |      | o +85 | -40 to | +125 | UNIT |
|                                    |  | WAVEFORING         | WAVEFORMS (pF) |                       | TYP. | MAX. | MIN. | MAX.  | MIN.   | MAX. |      |
| V <sub>CC</sub> = 4.5 t            | to 5.5 V; $R_L = 1 \text{ k}\Omega$ ;                | note 1             | -              | -                     | -    |      |      |       |        |      |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay V <sub>is</sub> to V <sub>os</sub> | see Figs 13 and 16 | 50             | _                     | 0.7  | 1.0  | _    | 2.0   | _      | 3.0  | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | turn-on time   | see Figs 14 and 16 | 15             | _                     | 3.0  | 7.0  | _    | 10.0  | _      | 13.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50             | _                     | 4.7  | 10.0 | _    | 13.0  | _      | 17.0 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | turn-off time  | see Figs 14 and 16 | 15             | _                     | 5.0  | 8.0  | _    | 10.0  | _      | 13.0 | ns   |
|                                    | E to V <sub>os</sub>                                 |                    | 50             | _                     | 6.5  | 11.0 | _    | 13.0  | _      | 17.0 | ns   |

#### Note

1. All typical values are measured at  $V_{CC} = 5 \text{ V}$ .

### TYPE 74AHC1G66 AND 74AHCT1G66

Recommended conditions and typical values. GND = 0 V;  $t_r = t_f = 3$  ns.  $V_{is}$  is the input voltage at pins Y or Z, whichever is assigned as an input.  $V_{os}$  is the output voltage at pin Y or Z, whichever is assigned as an output.

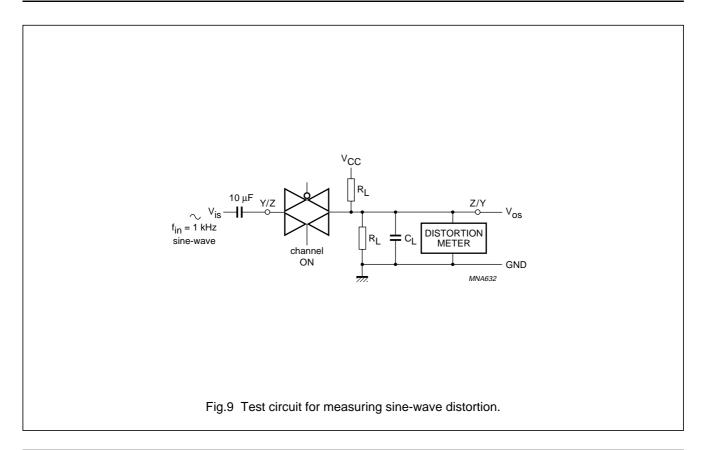
| SYMBOL           | PARAMETER                  | TEST CONDITIONS                                 | V <sub>is(p-p)</sub> (V) | V <sub>CC</sub> (V) | TYPICAL | UNIT |
|------------------|----------------------------|---|--------------------------|---------------------|---------|------|
|                  | sine-wave distortion at    | $R_L = 10 \text{ k}\Omega;$                     | 2.5                      | 3.0 to 3.6          | 0.025   | %    |
|                  | f <sub>in</sub> = 1 kHz    | $C_L = 50 \text{ pF}$ ; see Fig.9               | 4.0                      | 4.5 to 5.5          | 0.015   | %    |
|                  | sine-wave distortion at    | $R_L = 10 \text{ k}\Omega;$                     | 2.5                      | 3.0 to 3.6          | 0.025   | %    |
|                  | f <sub>in</sub> = 10 kHz   | $C_L = 50 \text{ pF}$ ; see Fig.9               | 4.0                      | 4.5 to 5.5          | 0.015   | %    |
|                  | switch OFF signal          | $R_L = 600 \Omega;$                             | note 1                   | 3.0 to 3.6          | -50     | dB   |
|                  | feed-through               | $C_L = 50 \text{ pF};$<br>f = 1 MHz; see Fig.10 |                          | 4.5 to 5.5          | -50     | dB   |
| f <sub>max</sub> | minimum frequency response | $R_L = 50 \Omega;$                              | note 2                   | 3.0 to 3.6          | 230     | MHz  |
|                  | (–3 dB)                    | C <sub>L</sub> = 10 pF;<br>see Figs 11 and 12   |                          | 4.5 to 5.5          | 280     | MHz  |

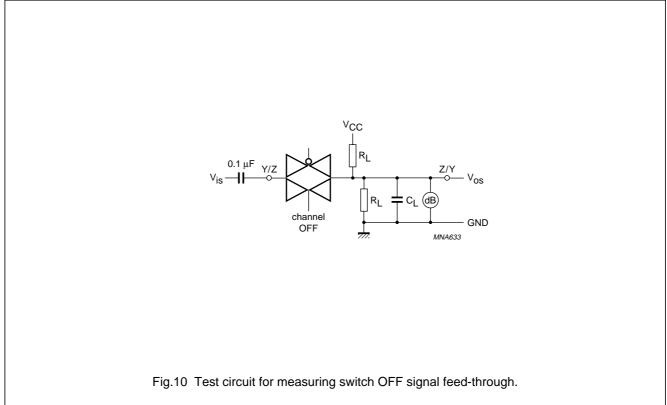
### Notes

- 1. Adjust input voltage  $V_{is}$  is 0 dBm level (0 dBm = 1 mW into 600  $\Omega$ ).
- 2. Adjust input voltage  $V_{is}$  is 0 dBm level at  $V_{os}$  for 1 MHz (0 dBm = 1 mW into 50  $\Omega$ ).

### Bilateral switch

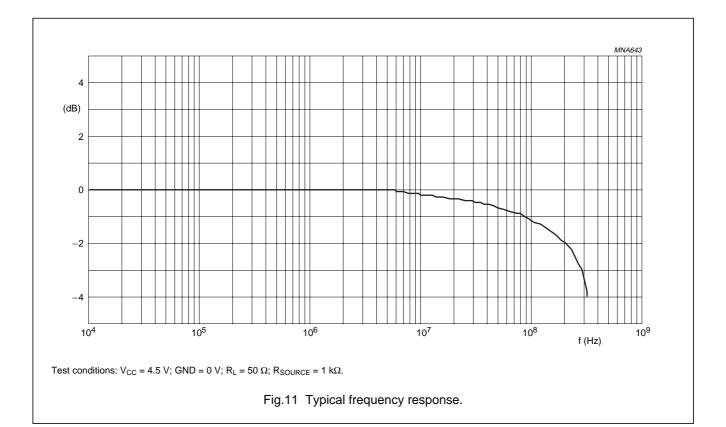
# 74AHC1G66; 74AHCT1G66





### Bilateral switch

# 74AHC1G66; 74AHCT1G66



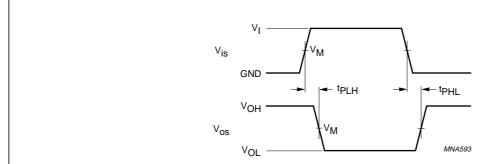
Adjust input voltage to obtain 0 dBm at  $V_{os}$  when f=1 MHz. After set-up, the frequency is increased to obtain a reading of -3 dB at  $V_{os}$ .

Fig. 12 Test circuit for measuring minimum frequency response.

### Bilateral switch

# 74AHC1G66; 74AHCT1G66

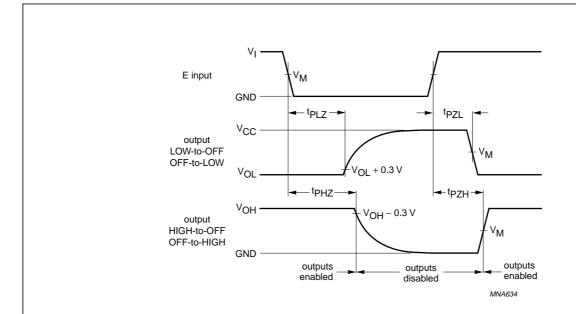
### **AC WAVEFORMS**



| V <sub>I</sub> INPUT<br>REQUIREMENTS | V <sub>M</sub> INPUT |  |
|--------------------------------------|----------------------|--|
| GND to V <sub>CC</sub>               | 50% V <sub>CC</sub>  |  |

 $\ensuremath{V_{\text{OL}}}$  and  $\ensuremath{V_{\text{OH}}}$  are typical output voltage drop that occur with the output load.

Fig.13 The input  $(V_{is})$  to output  $(V_{os})$  propagation delays.

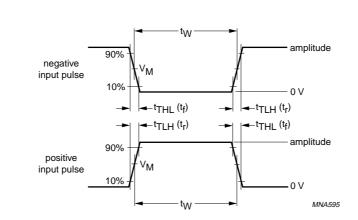


| TYPE   | V <sub>I</sub> INPUT<br>REQUIREMENTS | V <sub>M</sub> INPUT | V <sub>M</sub> OUTPUT |  |
|--------|--------------------------------------|----------------------|-----------------------|--|
| AHC1G  | GND to V <sub>CC</sub>               | 50% V <sub>CC</sub>  | 50% V <sub>CC</sub>   |  |
| AHCT1G | GND to 3.0 V                         | 1.5 V                | 1.5 V                 |  |

Fig.14 The turn-on and turn-off times.

### Bilateral switch

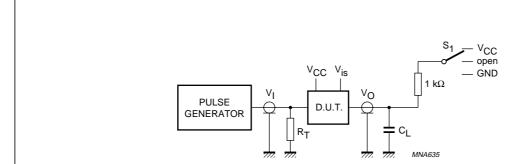
# 74AHC1G66; 74AHCT1G66



| FAMILY | V <sub>I</sub> INPUT<br>REQUIREMENTS | V <sub>M</sub> INPUT |
|--------|--------------------------------------|----------------------|
| AHC1G  | GND to V <sub>CC</sub>               | 50% V <sub>CC</sub>  |
| AHCT1G | GND to 3.0 V                         | 1.5 V                |

 $t_{\text{r}}$  =  $t_{\text{f}}$  = 3 ns, when measuring  $f_{\text{max}}$ , there is no constraint on  $t_{\text{r}}$ ,  $t_{\text{f}}$  with 50% duty factor.

Fig.15 Input pulse definitions.



| TEST                               | S <sub>1</sub>  | V <sub>is</sub> |  |  |
|------------------------------------|-----------------|-----------------|--|--|
| t <sub>PLH</sub> /t <sub>PHL</sub> | open            | pulse           |  |  |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>CC</sub> | GND             |  |  |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND             | V <sub>CC</sub> |  |  |

Definitions for test circuit:

 $C_L$  = load capacitance including jig and probe capacitance (see "AC characteristics" for values).

 $R_T$  = termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

Fig.16 Load circuitry for switching times.

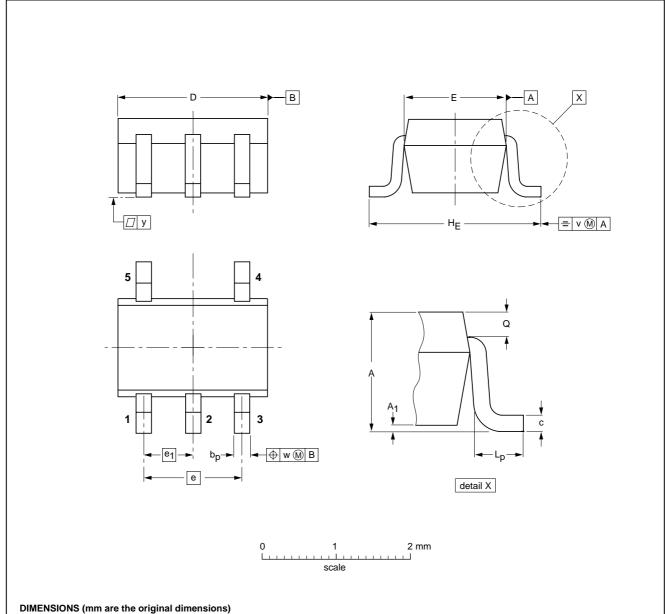
### Bilateral switch

# 74AHC1G66; 74AHCT1G66

### **PACKAGE OUTLINES**

Plastic surface mounted package; 5 leads

**SOT353** 



| UN | VIT | Α          | A <sub>1</sub><br>max | bp           | С            | D          | E <sup>(2)</sup> | е   | e <sub>1</sub> | HE         | Lp           | Q            | ٧   | w   | у   |
|----|-----|------------|-----------------------|--------------|--------------|------------|------------------|-----|----------------|------------|--------------|--------------|-----|-----|-----|
| m  | ım  | 1.1<br>0.8 | 0.1                   | 0.30<br>0.20 | 0.25<br>0.10 | 2.2<br>1.8 | 1.35<br>1.15     | 1.3 | 0.65           | 2.2<br>2.0 | 0.45<br>0.15 | 0.25<br>0.15 | 0.2 | 0.2 | 0.1 |

| OUTLINE |     | REFER | EUROPEAN        | ISSUE DATE |  |          |
|---------|-----|-------|-----------------|------------|--|----------|
| VERSION | IEC | JEDEC | EIAJ PROJECTION |            |  |          |
| SOT353  |     |       | SC-88A          |            |  | 97-02-28 |

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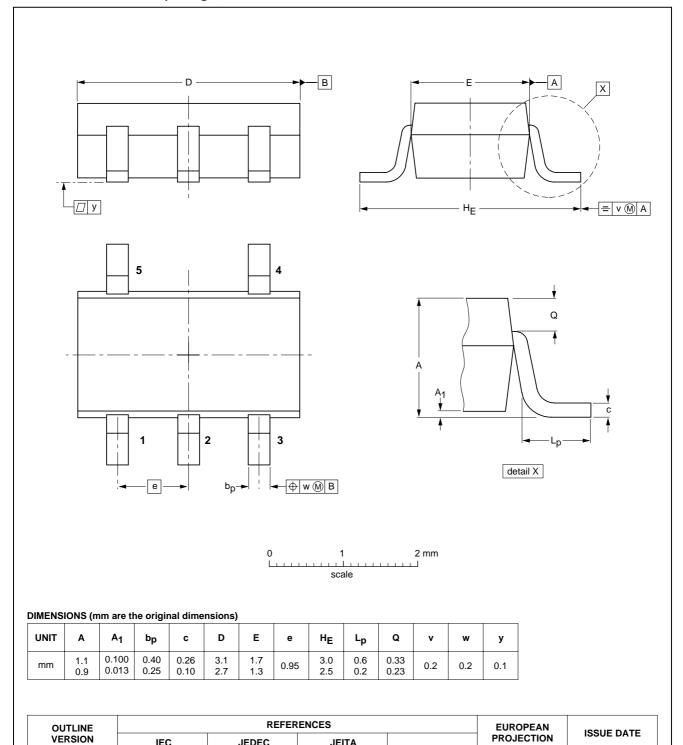
### Bilateral switch

### 74AHC1G66; 74AHCT1G66

#### Plastic surface mounted package; 5 leads

**SOT753** 

02-04-16



|  | SOT753 |  | SC-74A |  | 02-04- |
|--|--------|--|--------|--|--------|
|  |        |  |        |  |        |
|  |        |  |        |  |        |

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### Bilateral switch

### 74AHC1G66; 74AHCT1G66

#### **SOLDERING**

#### Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

### **Reflow soldering**

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferable be kept below 220 °C for thick/large packages, and below 235 °C for small/thin packages.

#### Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
  - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C. A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to  $300\ ^{\circ}$ C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320  $^{\circ}$ C.

### Bilateral switch

74AHC1G66; 74AHCT1G66

#### Suitability of surface mount IC packages for wave and reflow soldering methods

| PACKAGE <sup>(1)</sup>   | SOLDERING METHOD                  |                       |  |  |
|--|-----------------------------------|-----------------------|--|--|
| PACKAGE  | WAVE                              | REFLOW <sup>(2)</sup> |  |  |
| BGA, LBGA, LFBGA, SQFP, TFBGA, VFBGA                             | not suitable                      | suitable              |  |  |
| HBCC, HBGA, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, HVQFN, HVSON, SMS | not suitable <sup>(3)</sup>       | suitable              |  |  |
| PLCC <sup>(4)</sup> , SO, SOJ                                    | suitable                          | suitable              |  |  |
| LQFP, QFP, TQFP  | not recommended <sup>(4)(5)</sup> | suitable              |  |  |
| SSOP, TSSOP, VSO   | not recommended <sup>(6)</sup>    | suitable              |  |  |

#### **Notes**

- 1. For more detailed information on the BGA packages refer to the "(LF)BGA Application Note" (AN01026); order a copy from your Philips Semiconductors sales office.
- 2. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
- 3. These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- 4. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- 5. Wave soldering is suitable for LQFP, TQFP and QFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- 6. Wave soldering is suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

### Bilateral switch

### 74AHC1G66; 74AHCT1G66

#### **DATA SHEET STATUS**

| DATA SHEET STATUS(1) | PRODUCT<br>STATUS <sup>(2)</sup> | DEFINITIONS  |
|----------------------|----------------------------------|--|
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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NOTES

### Bilateral switch

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**NOTES** 

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